MSKSEMI 美森科













ESD

TVS

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MOV

GDT

PLED

PMBT3904MB(MS)

Product specification



MSKSEMI SEMICONDUCTOR

Features

- Low profile package
- Ideal for automated placement
- Low saturation voltages
- High voltage capability
- High Stability and High Reliability
- RoHS Compliant

Applications

- amplifying signal
- Electronic switch
- Oscillating circuit
- Variable resistance
- Lighting applications

PACKAGE OUTLINE	Pin Configuration	Marking
1: Base 2: Emitter 3: Collector DFN1006-3	Base Emitter	6P

Appearance & Symbol



Absolute Maximum Ratings (T=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector-Base Voltage	Vсво	60	V
Collector-Emitter Voltage	Vceo	40	V
Emitter-Base Voltage	Vebo	6	V
Collector Current Continuous	lc	0.2	A
Power Dissipation	PD	0.3	W
Operating Junction temperature	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise noted)

Parameter	Symbol	Test conditions	Min	Тур	Мах	Unit
Collector-Base Breakdown Voltage	V _{CBO}	I _C =10μΑ, I _E =0	60			V
Collector-Emitter Breakdown Voltage	V _{CER}	I _C =1mA,I _B =0	40			V
Emitter-Base Breakdown Voltage	V _{EBO}	I _E =10uA,I _C =0	6			V
Collector Cut-Off Current	I _{CBO}	V _{CB} =60V, I _E =0			100	nA
Collector Cut-Off Current	I _{CEX}	V _{CE} =30V,V _{EB(off)} =3V			50	nA
Emitter Cut-Off Current	I _{EBO}	V _{EB} =5V,I _C =0			100	nA
	h _{FE}	V _{CE} =1V,I _C =0.1mA	40			
		V _{CE} =1V,I _C =1mA	70			
DC current gain		V _{CE} =1V,I _C =10mA	100		300	
		V _{CE} =1V,I _C =50mA	60			
		V _{CE} =1V,I _C =100mA	30			
Collector-emitter saturation voltage	V _{CE(sat)}	Ic=50mA, Iв=5mA			0.3	V
Base -emitter saturation voltage	V _{BE(sat)}	I _C =50mA, I _B =5mA			0.95	V
Transition frequency	f⊤	V _{CE} = 20V, I _C =10mA,f=100MHz	300			MHZ
Delay Time	td	$V_{cc} = 3V_{c} I_{c} = 10 mA_{c}$		35		
Rise time	tr	$V_{BE(off)}$ =-0.5V, I _{B1} =1mA		35		ns
Storage time	ts	$V_{CC} = 3V, I_C = 10mA,$ $I_{B1} = I_{B2} = 1mA$		200		us
Fall time	tf			50		ns

Classification of hFE

Range

100-300



Typical Characteristics





Soldering parameters

Reflow Condition		Pb-Free assembly (see as bellow)
	-Temperature Min (T _{s(min)})	+150℃
Pre Heat	-Temperature Max(T _{s(max)})	+200 ℃
The field	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T∟) to peak)		3℃/sec. Max
T _{s(max)} to T _L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T _L) (Liquid us)	+217℃
	-Temperature(t _∟)	60-150 secs.
Peak Temp (T _p)		+260(+0/-5) ℃
Time within 5 $^\circ \!\!\!\!^{ m C}$ of actual Peak Temp (t _p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T _P)		8 min. Max
Do not exceed		+260 ℃





Package mechanical data



Suggested Land Pattern



Symbol	Dimension in Millimeters	
Symbol	typ	
X1	(0.3)	
X2	(0.35)	
Y1	(0.2)	
Y2	(0.6)	
Z	(0.4)	
Р	(0.7)	

REEL SPECIFICATION

P/N	PKG	QTY
MMBT3904MB(MS)	DFN1006-3	10000



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